






Series TW 2000

IC extractor tools with lifting mechanism and gripper device on the long edges

- Suitable for all DIP ICs provided that the IC stands at least 1 mm above the socket or circuit board.
- A 3 mm minimum gap is needed between the IC and adjacent ICs to allow the support spring plate to spread.

Illustration	Ordering NO.	Used for	Contact row spacing
	TW2000-14/20	14-20 pins	0.3 inch 7.62 mm
	TW2000-22	22 pins	0.4 inch 10.16 mm
	TW2000-24	24-28 pins	0.6 inch 15.24 mm
	TW2000-40	40-48 pins	0.6 inch 15.24 mm
	TW2000-64	64 pins	0.9 inch 22.86 mm